Tyrone Camarero Specifications

Camarero DS40012E1-224RLT

Key features

- Corporate Database, Database Processing & Storage, Enterprise Server, HPC, Data Center, iSCSI SAN
- 2nd Generation Intel® Xeon® Scalable Processors (Cascade Lake-SP), Intel® Xeon® Scalable Processors, Dual Socket P (LGA 3647) supported, CPU TDP support Up to 140W, 2 UPI up to 10.4 GT/s
- · Intel® C622 chipset
- Up to 2TB 3DS ECC RDIMM, DDR4-2933MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-2933MHz, in 8 DIMM slots
- 3 PCI-E 3.0 x16, 4 PCI-E 3.0 x8,(slot 2 & 3 occupied by controller and JBOD expansion port)
- 24 Hot-swap 2.5" SAS3/SATA3 drive bays;2 Hot-swap 2.5" SATA3 drive bays (rear), Expander based backplane
- · Broadcom 3008 SAS3 AOC
- 2x 10GBase-T LAN ports with Intel X722 + PHY Intel X557
- Server remote management: IPMI 2.0 / KVM over LAN / Media over LAN
- 3 Hot-swap 8cm redundant PWM fans
- 1200W Redundant Power Supplies Titanium Level (96%)









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Processor

2nd Generation Intel® Xeon® Scalable
Processors (Cascade Lake-SP), Intel®
Xeon® Scalable Processors, Dual Socket P

(LGA 3647) supported, CPU TDP support Up to 140W, 2 UPI up to 10.4 GT/s

Chipset

Chipset Intel® C622 chipset

System Memory

Memory Capacity Up to 2TB 3DS ECC RDIMM,

DDR4-2933MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-2933MHz, in 8 DIMM slots

Expansion Slots

PCI-Express 3 PCI-E 3.0 x16 slot,4 PCI-E 3.0 x8 slots,

Slot 2 & 3 occupied by controller and

SJBOD Expansion Port

Integrated On-Board

SAS SAS 3 (12Gbps) via Broadcom 3008 AOC,

Broadcom 3008 controller

SATA SATA 3 (6Gbps); RAID 0, 1, 5, 10

LAN 2 RJ45 10GBase-T LAN ports.1

RJ45 Dedicated IPMI LAN port

Add-on Options

Optical Drive None

Front Panel

LED Indicators LED Indicators:Power status LED,Hard

drive activity LED, Network activity LEDs, System Information LED, Power fail LED

Buttons Power On/Off button, System Reset button

Drive Bays

HDD Bays 24 Hot-swap 2.5" SAS3/SATA3 drive bays

Optional 2 Optional Onboard NVMe M.2

Power Supply

1200W Redundant Power Supplies Titanium Level (96%)

Cooling System

3 Hot-swap 8cm redundant PWM cooling fans

Form Factor

Form Factor 2U Rackmount

Height: 3.5* (89 mm), Width: 17.2* (437 mm), Depth: 24.8" (630 mm)

Email: info@tyronesystems.com

For more/current product information, visit www.tyronesystems.com

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